# ALICE status update

Marco van Leeuwen, Nikhef and CERN

CERN-Korea Committee meeting 22 April 2024



## ALICE collaboration updates

ALICE collaboration:

- 1069 authors
- 173 institutes in 40 countries

New associate member institutes

- MCAST, Malta
- CHPC, South Africa
- Dhaka, Bangladesh

### 9 Korean Institutes, 45 active members 33 authors



ALICE Week, March 2024







## Run 3 heavy-ion data taking

- Successful heavy-ion run  $\bullet$ 
  - Total recorded luminosity: 1.5 nb<sup>-1</sup> 11.5 G events
  - 40x more minimum bias events than in run 2  $\bullet$
  - Total run time: about 6 weeks
- Reconstruction in progress:
  - Test pass on 20% of data sample to verify reconstruction  $\bullet$ performance and refine calibrations
  - Second pass in progress
- Aim to collect similar size data sample in three-week run in 2024

4.5 pb<sup>-1</sup> pp collisions at same energy for reference



full system validated up to target interaction rate (50 kHz) data rates: 600-800 GB/s input to FLPs, 160-190 GB/s to EOS









## f<sub>0</sub>(980) production in p-Pb collisions



Unexpected suppression of  $f_0(980)$  production in central p-Pb collisions — rescattering of decay products ?

Paper committee member: Junlee Kim (Jeonbuk Nat Univ, now CERN)



4

## Charm baryon production in jets

Phys. Rev. D 109 (2024) 072005



- Production of charm baryons in pp collisions larger than expected from e<sup>+</sup>e<sup>-</sup> collisions (breaking of factorisation)
- New measurement of charm baryon production in jets:
  - Baryon distribution softer than mesons
  - Matches well with a model that includes color recombination and baryon junctions

Paper Committee member: Vit Kucera (Inha University)



ALI-PUB-569701







## 11<sup>th</sup> annual ALICE Tier1/Tier2 workshop

Organized by KISTI-GSDC, co-sponsored by KSHEP

45 participants from Asia, Europe, North and South America

Computing centre managers, network experts, Grid software developers and security









Global Science experimental Data hub Center

Thank you for hosting this important event!

#### 16-18 April 2024 in Seoul

#### Discussions on

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- Status and future development of the Grid middleware Network infrastructure
- Site operation and resources planning
- Integration of HPC systems, e.g. NURION at KISTI
- Grid and site computing security





## Upgrades: ITS3, FoCal and ALICE 3



#### ALICE Upgrade week, <u>4-7 December 2023, Torino</u>

ALICE update | CKC meeting 22 April 2024 | Marco van Leeuwen



#### ALICE 3 Days, 25-27 March, CERN





## LS3 upgrades: ITS 3 — ultra-light fully cylindrical tracking layers



ITS3: replace inner three layers of ITS with ultralight tracker

- Large-area curved sensors (stitched CMOS) lacksquare
- Air cooling low power
- Improve performance for heavy flavour, dielectrons (thermal  $\bullet$ radiation) — physics performance note

New Engineering Run 1 stitched sensors being tested

**TDR** approved (CERN-LHCC-2024-003)

Handling of stitched structures



Beam tests







## ALICE 3 upgrade

ALICE 3 design:

- Compact and lightweight all-silicon tracker
  - Excellent pointing resolution with a retractable vertex detector
- Extensive particle identification: TOF, RICH
- Large acceptance

Sensor R&D started: test beams for MID, ECal, RICH TOF

Cost and schedule: Scoping Document

- Two main scoping options defined:
  - Setup without ECal
  - Reduced magnetic field: ~ 1 T

Scoping Document reviewed by editorial committee

Measureme
ALPs searches in 7
$\chi_{c1,2} \rightarrow J\psi$
$\chi_{c1}(3872) \rightarrow Ju$
$\Xi_{cc}$
$B^+$ yield and f
$\Lambda_{\rm c}$ flow
$\Lambda_{\rm b}$ flow
$D^0 - \overline{D^0}$ vs. $\Delta$







## Outer tracker R&D: module production

# Commercial general purpose die attach machine







**Tests with Korean company: MEMSPACK** 

- Large area: automated industrial production of multi-chip modules
- First tests with dummy modules in collaboration with industry

#### Chip holder



#### Chip gripper



#### Marker scan



Position reproducible with 5 µm level accuracy



on of multi-chip modules on with industry

Module -







## R&D for ALICE 3: module production

### Key R&D item for ALICE 3: automated module assembly

Multi-chip modules to assembly large area

R&D with MEMSPACK to develop assembly process

- First tests of position accuracy very promising
- Next step: test with glueing
  - Determines production throughput
- Important input for module design, schedule and cost estimates



Automatic glue dispensing

#### **Test sensor positioning**







11

## Conclusion

- Run 2 data continues to produce new results
- Processing of Pb-Pb data is advancing aim for first results in summer
- ALICE Tier-1/2 workshop hosted by KISTI
- R&D for ITS3 and ALICE 3 progressing well

### Thank you for your support and attention





# Extra slides

## KISTI contribution to ALICE computing



- Joined ALICE Grid in 2007
- Substantial contribution to ALICE computing
- Only Tier 1 in Asia: very reliable operation
- Important regional function

- KISTI provides 15% of the ALICE T1 resources and 50% of the computing capacity in Asia
- Robust growth over the past 11 years, today more than 3500 CPU cores and about 20 PB of storage





